



Product Change Notification

109998 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification #: 109998 - 00
Change Title: Intel® Modular Server System MFSYS25, Intel® Modular Server System MFSYS35, AXXPSU 1000W Power Supply Module, PCN 109998-00, Product Material, Adding updated power supply module to system chassis'.
Date of Publication: April 27, 2010

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 28, 2010
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Description of Change to the Customer:

Adding updated power supply modules to the system chassis'.

Power supply modules were updated by adding rubber fan isolation bumpers within each power supply to add margin for Rotational Vibration (RVI) control allowing more hard disk drives (HDD) to pass RVI validation and be added to the tested HDD list. Reference PCN109736-02 for power supply module update details.

Customer Impact of Change and Recommended Action:

Intel anticipates no impact to customers so no action is recommended or required.

Products Affected / Intel Ordering Codes:

Pre Change Product Code	Pre Change MM#	Pre Change TA	Pre Change CA	Post Change Product Code	Post Change MM#	Post Change TA	Post Change CA
MFSYS25	902318	D91400-012	D73299-007	MFSYS25	902318	D91400-013	D73299-008
MFSYS35	902319	D91403-009	D73299-007	MFSYS35	902319	D91403-010	D73299-008

Reference Documents / Attachments:

Document: **Location #:**

PCN Revision History:

Date of Revision:

April 27, 2010

Revision Number:

00

Reason:

Originally Published PCN